

MC74HC138ADG Datasheet

Manu

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| DiGi Electronics Part Number | MC74HC138ADG-DG |
|------------------------------|---------------------------------------|
| Manufacturer | onsemi |
| Aanufacturer Product Number | MC74HC138ADG |
| Description | IC DECODER/DEMUX 1X3:8 16SOIC |
| Detailed Description | Decoder/Demultiplexer 1 x 3:8 16-SOIC |
| | |

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Purchase and inquiry

| Manufacturer Product Number: | Manufacturer: |
|--|---|
| MC74HC138ADG | onsemi |
| Series: | Product Status: |
| 74HC | Active |
| Type: | Circuit: |
| Decoder/Demultiplexer | 1 x 3:8 |
| Independent Circuits: | Current - Output High, Low: |
| 1 | 5.2mA, 5.2mA |
| Voltage Supply Source: | Voltage - Supply: |
| Single Supply | 2V ~ 6V |
| Operating Temperature: | Mounting Type: |
| -55°C ~ 125°C | Surface Mount |
| Package / Case: | Supplier Device Package: |
| 16-SOIC (0.154", 3.90mm Width) | 16-SOIC |
| Base Product Number: | |
| 74HC138 | |
| 1Voltage Supply Source:Single SupplyOperating Temperature:-55°C ~ 125°CPackage / Case:16-SOIC (0.154", 3.90mm Width)Base Product Number: | 5.2mA, 5.2mA Voltage - Supply: 2V ~ 6V Mounting Type: Surface Mount Supplier Device Package: |

Environmental & Export classification

| RoHS Status: | Moisture Sensitivity Level (MSL): |
|------------------|-----------------------------------|
| ROHS3 Compliant | 1 (Unlimited) |
| REACH Status: | ECCN: |
| REACH Unaffected | EAR99 |
| HTSUS: | |
| 8542.39.0001 | |

Onsemi

1-of-8 Decoder/ Demultiplexer

High-Performance Silicon-Gate CMOS

MC74HC138A, **MC74HCT138A**

The MC74HC138A/MC74HCT138A is identical in pinout to the LS138. The MC74HC138A inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs. The MC74HCT138A may be used as a level converter for interfacing TTL or NMOS outputs to High Speed CMOS inputs.

The device decodes a three-bit Address to one-of-eight active-low outputs. This device features three Chip Select inputs, two active-low and one active-high to facilitate the demultiplexing, cascading, and chip-selecting functions. The demultiplexing function is accomplished by using the Address inputs to select the desired device output; one of the Chip Selects is used as a data input while the other Chip Selects are held in their active states.

Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS and TTL
- Operating Voltage Range: 2.0 to 6.0 V (HC), 4.5 to 5.5 V (HCT)
- Low Input Current: 1.0 μA
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7 A
- Chip Complexity: 122 FETs or 30.5 Equivalent Gates
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable*
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



SOIC-16 **D SUFFIX** CASE 751B

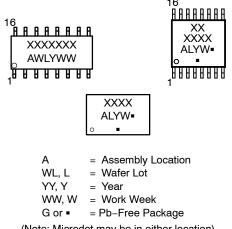


TSSOP-16 DT SUFFIX CASE 948F



QFN16 **MN SUFFIX** CASE 485AW

MARKING DIAGRAMS



(Note: Microdot may be in either location)

| ao C | 1● | 16 | l v _{cc} |
|-------|----|----|-------------------|
| A1 [| 2 | 15 |] Y0 |
| A2 [| 3 | 14 | I Y1 |
| CS2 [| 4 | 13 | 1 Y2 |
| сѕз 🛛 | 5 | 12 | I Y3 |
| CS1 [| 6 | 11 |] Y4 |
| Y7 🛛 | 7 | 10 | 1 Y5 |
| GND [| 8 | 9 |] Y6 |
| | | | |

PIN ASSIGNMENT

ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

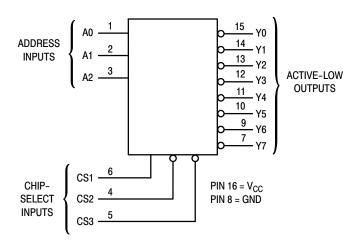


Figure 1. Logic Diagram

FUNCTION TABLE

| | Inputs | | | | | | Ou | tput | s | | | | |
|----|--------|-----|----|-----------|-----------|----|------------|------|------------|------------|----|----|------------|
| CS | 1 CS2 | CS3 | A2 | A1 | A0 | Y0 | Y 1 | Y2 | Y 3 | Y 4 | Y5 | Y6 | Y 7 |
| Х | Х | Н | Х | Х | Х | Н | Н | Н | Н | Н | Н | Н | Н |
| Х | Н | Х | Х | Х | Х | Н | н | Н | н | Н | Н | Н | Н |
| L | Х | Х | Х | Х | Х | Н | н | Н | н | Н | Н | Н | Н |
| Н | L | L | L | L | L | L | Н | Н | Н | Н | Н | Н | Н |
| Н | L | L | L | L | Н | Н | L | Н | н | Н | Н | Н | Н |
| Н | L | L | L | н | L | Н | Н | L | Н | Н | Н | Н | Н |
| Н | L | L | L | Н | Н | н | Н | Н | L | Н | Н | Н | Н |
| Н | L | L | Н | L | L | Н | Н | Н | Н | L | Н | Н | Н |
| Н | L | L | н | L | Н | Н | н | н | н | Н | L | н | Н |
| Н | L | L | н | н | L | Н | н | Н | н | Н | Н | L | Н |
| Н | L | L | н | Н | Н | Н | Н | Н | Н | Н | Н | Н | L |
| | | | | | | | | | | | | | |

H = high level (steady state);

L = low level (steady state);

X = don't care

MAXIMUM RATINGS

| Symbol | Parameter | | Value | Unit |
|------------------|--|--|--------------------------|------|
| V _{CC} | DC Supply Voltage | | -0.5 to +6.5 | V |
| V _{IN} | DC Input Voltage | | -0.5 to V_{CC} + 0.5 | V |
| V _{OUT} | DC Output Voltage | | -0.5 to V_{CC} + 0.5 | V |
| I _{IN} | DC Input Current, per Pin | | ±20 | mA |
| I _{OUT} | DC Output Current, per Pin | | ±25 | mA |
| I _{CC} | DC Supply Current, V_{CC} and GND Pins | | ±50 | mA |
| Ι _{ΙΚ} | Input Clamp Current ($V_{IN} < 0$ or $V_{IN} > V_{CC}$) | | ±20 | mA |
| I _{OK} | Output Clamp Current (V _{OUT} < 0 or V _{OUT} > V _{CC}) | | ±20 | mA |
| T _{STG} | Storage Temperature | | 65 to +150 | °C |
| ΤL | Lead Temperature, 1 mm from Case for 10 Seconds | | 260 | °C |
| TJ | Junction Temperature Under Bias | | ±150 | °C |
| θ_{JA} | Thermal Resistance (Note 1) | SOIC-16 QFN16 TSSOP-16 | 126 118 159 | °C/W |
| P _D | Power Dissipation in Still Air at 25°C | SOIC-16 QFN16 TSSOP-16 | 995 1062 787 | mW |
| MSL | Moisture Sensitivity | | Level 1 | - |
| F _R | Flammability Rating | Oxygen Index: 28 to 34 | UL 94 V-0 @ 0.125 in | - |
| V _{ESD} | ESD Withstand Voltage (Note 2) | Human Body Model Charged Device Model | 2000 N/A | V |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
|-----------------------------------|---|-------------|--------------------|------|
| MC74HC | | | | |
| V _{CC} | DC Supply Voltage | 2.0 | 6.0 | V |
| V _{IN,} V _{OUT} | DC Input, Output Voltage (Note 3) | 0 | V _{CC} | V |
| T _A | Operating Free-Air Temperature | -55 | +125 | °C |
| t _r , t _f | Input Rise or Fall Time $V_{CC} = 2.0 \ V \\ V_{CC} = 4.5 \ V \\ V_{CC} = 6.0 \ V \label{eq:VCC}$ | 0 0 0 | 1000 500 400 | ns |

MC74HCT

| V _{CC} | DC Supply Voltage | 4.5 | 5.5 | V |
|---------------------------------|-----------------------------------|-----|-----------------|----|
| $V_{IN,} V_{OUT}$ | DC Input, Output Voltage (Note 3) | 0 | V _{CC} | V |
| T _A | Operating Free-Air Temperature | -55 | +125 | °C |
| t _r , t _f | Input Rise or Fall Time | 0 | 500 | ns |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

| | | | v _{cc} | Guara | nteed Limit | | |
|-----------------|---|--|--------------------------|---------------------------|---------------------------|---------------------------|------|
| Symbol | Parameter | Test Conditions | V | –55°C to 25°C | ≤ 85°C | ≤125°C | Unit |
| V _{IH} | Minimum High–Level Input Voltage | $ \begin{aligned} V_{out} &= 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ I_{out} &\leq 20 \ \mu\text{A} \end{aligned} $ | 2.0 3.0 4.5 6.0 | 1.5 2.1 3.15 4.2 | 1.5 2.1 3.15 4.2 | 1.5 2.1 3.15 4.2 | V |
| V _{IL} | Maximum Low–Level Input Voltage | $\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ I_{out} \leq 20 \ \mu\text{A} \end{array}$ | 2.0 3.0 4.5 6.0 | 0.5 0.9 1.35 1.8 | 0.5 0.9 1.35 1.8 | 0.5 0.9 1.35 1.8 | V |
| V _{OH} | Minimum High-Level Output Voltage | $\begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ \left I_{out} \right \leq 20 \; \mu A \end{array} \end{array}$ | 2.0 4.5 6.0 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | V |
| | | $\begin{array}{l l} V_{in} = V_{IH} \text{ or } V_{IL} & \left I_{out}\right \leq 2.4 \text{ mA} \\ \left I_{out}\right \leq 4.0 \text{ mA} \\ \left I_{out}\right \leq 5.2 \text{ mA} \end{array}$ | 3.0 4.5 6.0 | 2.48 3.98 5.48 | 2.34 3.84 5.34 | 2.20 3.70 5.20 | |
| V _{OL} | Maximum Low-Level Output Voltage | $\begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ I_{out} \leq 20 \; \mu A \end{array}$ | 2.0 4.5 6.0 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | V |
| | | $\label{eq:Vin} \begin{array}{l l} V_{in} = V_{IH} \text{ or } V_{IL} & I_{out} \leq 2.4 \text{ mA} \\ I_{out} \leq 4.0 \text{ mA} \\ I_{out} \leq 5.2 \text{ mA} \end{array}$ | 3.0 4.5 6.0 | 0.26 0.26 0.26 | 0.33 0.33 0.33 | 0.40 0.40 0.40 | |
| l _{in} | Maximum Input Leakage Cur- rent | V _{in} = V _{CC} or GND | 6.0 | ±0.1 | ±1.0 | ±1.0 | μΑ |
| I _{CC} | Maximum Quiescent Supply Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$ | 6.0 | 4 | 40 | 160 | μΑ |

DC ELECTRICAL CHARACTERISTICS (MC74HC138A)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (MC74HC138A)

| | | V _{CC} | Guara | | | |
|--|--|--------------------------|-----------------------|------------------------|------------------------|------|
| Symbol | Parameter | v | –55°C to 25°C | ≤ 85°C | ≤125°C | Unit |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, Input A to Output Y (Figures 2 and 3) | 2.0 3.0 4.5 6.0 | 135 90 27 23 | 170 125 34 29 | 205 165 41 35 | ns |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, CS1 to Output Y (Figures 2 and 4) | 2.0 3.0 4.5 6.0 | 110 85 22 19 | 140 100 28 24 | 165 125 33 28 | ns |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, CS2 or CS3 to Output Y (Figures 2 and 5) | 2.0 3.0 4.5 6.0 | 120 90 24 20 | 150 120 30 26 | 180 150 36 31 | ns |
| t _{TLH} , t _{THL} | Maximum Output Transition Time, Any Output (Figures 2 and 4) | 2.0 3.0 4.5 6.0 | 75 30 15 13 | 95 40 19 16 | 110 55 22 19 | ns |
| C _{in} | Maximum Input Capacitance | - | 10 | 10 | 10 | pF |

| | | Typical @ 25°C, V _{CC} = 5.0 V | |
|-----------------|--|---|----|
| C _{PD} | Power Dissipation Capacitance (Per Package)* | 55 | pF |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. *Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

DC ELECTRICAL CHARACTERISTICS (MC74HCT138A)

| | | | | Gu | | | |
|-----------------|---|--|----------------------|----------------|------------|------------|------|
| Symbol | Parameter | Test Conditions | V _{CC} V | -55 to 25°C | ≤85°C | ≤125°C | Unit |
| V _{IH} | Minimum High-Level Input Voltage | $ \begin{array}{l} V_{out} = 0.1 \ V \ or \ V_{CC} - 0.1 \ V \\ \left I_{out} \right \leq 20 \ \mu A \end{array} $ | 4.5 5.5 | 2.0 2.0 | 2.0 2.0 | 2.0 2.0 | V |
| V _{IL} | Maximum Low-Level Input Voltage | $ \begin{array}{l} V_{out} = 0.1 \ V \ or \ V_{CC} - 0.1 \ V \\ \left I_{out} \right \leq 20 \ \mu A \end{array} $ | 4.5 5.5 | 0.8 0.8 | 0.8 0.8 | 0.8 0.8 | V |
| V _{OH} | Minimum High-Level Output Voltage | $ \begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ \left I_{out} \right \leq 20 \ \mu A \end{array} $ | 4.5 5.5 | 4.4 5.4 | 4.4 5.4 | 4.4 5.4 | V |
| | | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 4.0 \text{ mA}$ | 4.5 | 3.98 | 3.84 | 3.7 | |
| V _{OL} | Maximum Low-Level Output Voltage | $ \begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ \left I_{out} \right \leq 20 \ \mu A \end{array} $ | 4.5 5.5 | 0.1 0.1 | 0.1 0.1 | 0.1 0.1 | V |
| | | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 4.0 \text{ mA}$ | 4.5 | 0.26 | 0.33 | 0.4 | |
| l _{in} | Maximum Input Leakage Current | V _{in} = V _{CC} or GND | 6.0 | ±0.1 | ±1.0 | ±1.0 | μA |
| ICC | Maximum Quiescent Supply Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$ | 5.5 | 4.0 | 40 | 160 | μΑ |

| | Additional Quiescent Supply | V_{in} = 2.4 V, Any One Input V_{in} = V _{CC} or GND, Other Inputs | | ≥–55°C | 25°C to 125°C | |
|-----------------|-----------------------------|--|-----|--------|---------------|----|
| ΔI_{CC} | Current | $V_{in} = V_{CC} \text{ or GND, Other inputs}$ $I_{out} = 0 \mu\text{A}$ | 5.5 | 2.9 | 2.4 | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

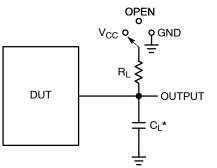
AC ELECTRICAL CHARACTERISTICS (MC74HCT138A)

| | | Gu | aranteed Li | mit | |
|--|---|----------------|-------------|--------|------|
| Symbol | Parameter | –55 to 25°C | ≤85°C | ≤125°C | Unit |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, Input A to Output Y (Figures 2 and 3) | 30 | 38 | 45 | ns |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, CS1 to Output Y (Figures 2 and 4) | 27 | 34 | 41 | ns |
| t _{PLH} , t _{PHL} | Maximum Output Transition Time, CS2 or CS3 to Output Y (Figures 2 and 5) | 30 | 38 | 45 | ns |
| t _{TLH} , t _{THL} | Maximum Output Transition Time, Any Output (Figures 2 and 4) | 15 | 19 | 22 | ns |
| t _r , t _f | Maximum Input Rise and Fall Time | 500 | 500 | 500 | ns |
| C _{in} | Maximum Input Capacitance | 10 | 10 | 10 | pF |

| | | Typical @ 25°C, V _{CC} = 5.0 V | |
|-----------------|---|---|----|
| C _{PD} | Power Dissipation Capacitance (Per Enabled Output)* | 51 | pF |

*Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

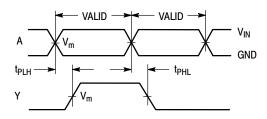
SWITCHING WAVEFORMS



| Test | Switch Position | CL | RL |
|-------------------------------------|-----------------|-------|------|
| t _{PLH} / t _{PHL} | Open | 50 pF | 1 kΩ |
| t _{PLZ} / t _{PZL} | V _{CC} | | |
| t _{PHZ} / t _{PZH} | GND | | |

 $^{\ast}\text{C}_{\text{L}}$ Includes probe and jig capacitance





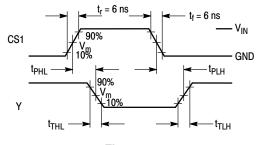


Figure 3.



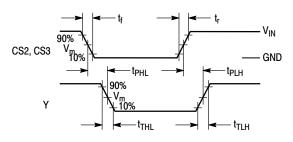


Figure 5.

| Device | V _{IN} , V | V _m , V |
|-------------|---------------------|-----------------------|
| MC74HC138A | V _{CC} | 50% x V _{CC} |
| MC74HCT138A | 3 V | 1.3 V |

PIN DESCRIPTIONS

ADDRESS INPUTS

A0, A1, A2 (Pins 1, 2, 3)

Address inputs. These inputs, when the chip is selected, determine which of the eight outputs is active–low.

CONTROL INPUTS

CS1, CS2, CS3 (Pins 6, 4, 5)

Chip select inputs. For CS1 at a high level and CS2, CS3 at a low level, the chip is selected and the outputs follow the

Address inputs. For any other combination of CS1, CS2, and CS3, the outputs are at a logic high.

OUTPUTS

Y0 - Y7 (Pins 15, 14, 13, 12, 11, 10, 9, 7)

Active-low Decoded outputs. These outputs assume a low level when addressed and the chip is selected. These outputs remain high when not addressed or the chip is not selected.

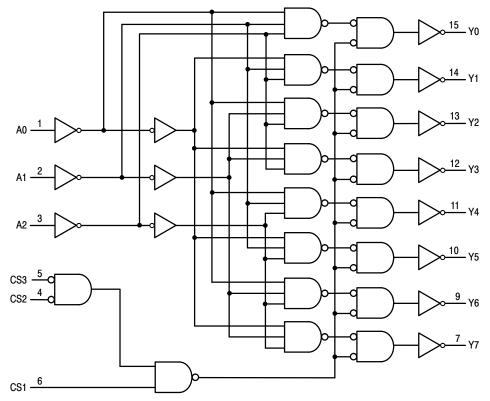


Figure 6. Expanded Logic Diagram

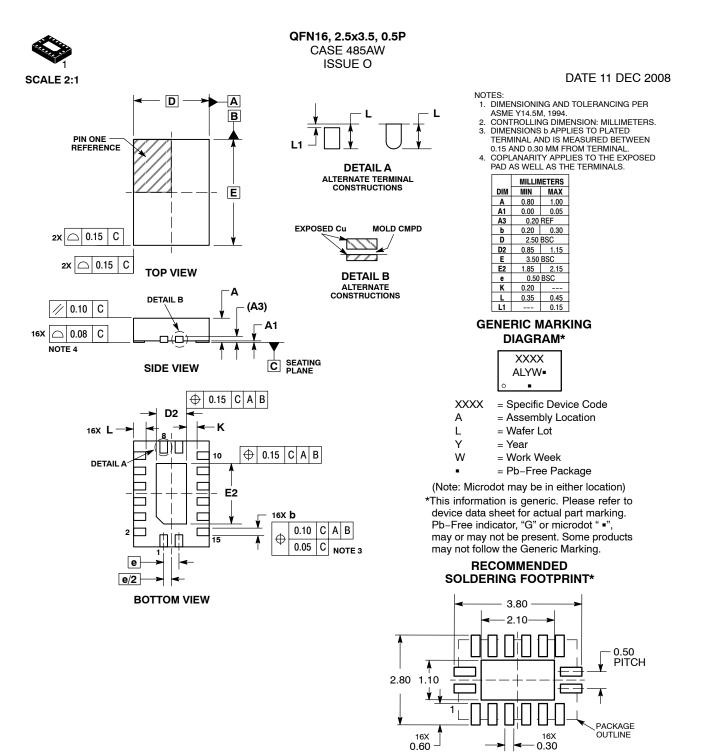
ORDERING INFORMATION

| Device | Marking | Package | Shipping [†] |
|--------------------|-------------|----------|-----------------------|
| MC74HC138ADG | HC138AG | SOIC-16 | 48 Units / Rail |
| MC74HC138ADR2G | HC138AG | SOIC-16 | 2500 / Tape & Reel |
| MC74HC138AD2G-Q* | HC138AG | SOIC-16 | 2500 / Tape & Reel |
| MC74HC138ADTR2G | HC 138A | TSSOP-16 | 2500 / Tape & Reel |
| MC74HC138ADTR2G-Q* | HC 138A | TSSOP-16 | 2500 / Tape & Reel |
| MC74HCT138ADR2G | HCT138AG | SOIC-16 | 2500 / Tape & Reel |
| MC74HCT138ADTR2G | HCT 138A | TSSOP-16 | 2500 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DIMENSIONS: MILLIMETERS



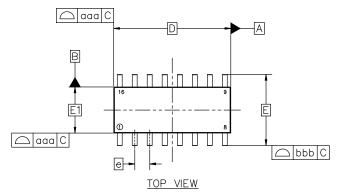
SOIC-16 9.90x3.90x1.37 1.27P CASE 751B ISSUE M

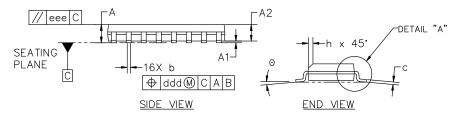
DATE 18 OCT 2024

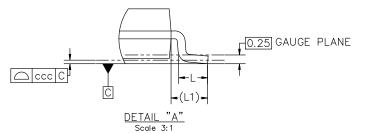
MAX

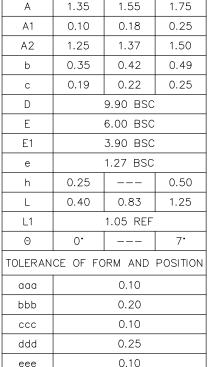
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
- 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE & DIMENSION AT MAXIMUM MATERIAL CONDITION.







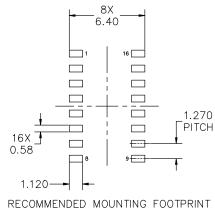


MILLIMETERS

NOM

MIN

DIM



ECOMMENDED MOUNTING FOOTPRINT *FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATECY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE onsemi SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D

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|------------------|---|--|-------------|
| DESCRIPTION: | SOIC-16 9.90X3.90X1.37 1.27P | | PAGE 1 OF 2 |
| | | | |

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DATE 18 OCT 2024

GENERIC MARKING DIAGRAM*

| 16 | A | H | A. | - A | R | A | A | Æ |
|----|---|-----|-----|-----|----|-----|----|---|
| | | XX) | XX | X | XX | XX | XX | G |
| | | XX | XX) | XX | XX | XX) | XX | x |
| | 0 | | A١ | NĽ | YW | /W | | |
| 1 | H | Н | Н | Н | Н | H | H | Ъ |

XXXXX = Specific Device Code

= Assembly Location

- WL = Wafer Lot
- Y = Year

А

- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

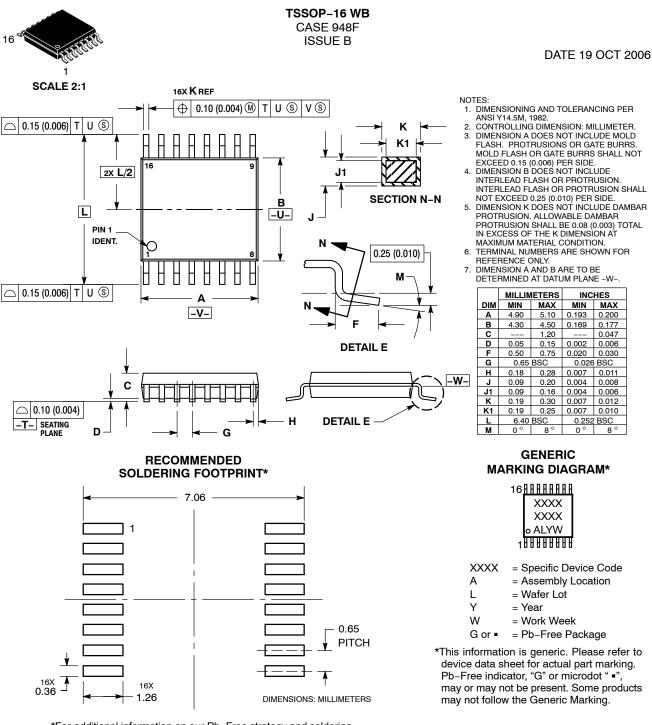
| STYLE 1: | | STYLE 2: | | STYLE 3: | c | TYLE 4: | |
|----------|---------------|----------|---------------|----------|-----------------------|---------|-------------------|
| PIN 1. | COLLECTOR | PIN 1. | CATHODE | PIN 1. | | PIN 1. | COLLECTOR, DYE #1 |
| | BASE | 2. | ANODE | 2. | BASE. #1 | 2. | |
| 3. | EMITTER | 3. | NO CONNECTION | 3. | EMITTER. #1 | 3. | |
| 4. | NO CONNECTION | 4. | CATHODE | 4. | COLLECTOR. #1 | 4. | |
| 5. | EMITTER | 5. | CATHODE | 5. | COLLECTOR, #2 | 5. | |
| 6. | BASE | 6. | NO CONNECTION | 6. | BASE, #2 | 6. | |
| 7. | COLLECTOR | 7. | | 7. | EMITTER, #2 | 7. | |
| 8. | COLLECTOR | 8. | CATHODE | 8. | | 8. | |
| 9. | BASE | 9. | CATHODE | 9. | COLLECTOR, #3 | 9. | |
| 10. | EMITTER | 10. | ANODE | | BASE, #3 | 10. | EMITTER, #4 |
| 11. | NO CONNECTION | 11. | NO CONNECTION | 11. | EMITTER, #3 | 11. | BASE, #3 |
| 12. | EMITTER | 12. | CATHODE | 12. | COLLECTOR, #3 | 12. | EMITTER, #3 |
| 13. | BASE | 13. | CATHODE | 13. | COLLECTOR, #4 | 13. | BASE, #2 |
| 14. | COLLECTOR | 14. | NO CONNECTION | 14. | BASE, #4 | 14. | EMITTER, #2 |
| 15. | EMITTER | 15. | ANODE | 15. | EMITTER, #4 | 15. | |
| 16. | COLLECTOR | 16. | CATHODE | 16. | COLLECTOR, #4 | 16. | EMITTER, #1 |
| | | | | | | | |
| STYLE 5: | | STYLE 6: | | STYLE 7: | | | |
| PIN 1. | DRAIN, DYE #1 | PIN 1. | CATHODE | PIN 1. | SOURCE N-CH | | |
| 2. | DRAIN, #1 | 2. | CATHODE | 2. | COMMON DRAIN (OUTPUT) | | |
| 3. | DRAIN, #2 | 3. | CATHODE | 3. | COMMON DRAIN (OUTPUT) | | |
| 4. | DRAIN, #2 | 4. | CATHODE | 4. | GATE P-CH | | |
| 5. | DRAIN, #3 | 5. | CATHODE | 5. | COMMON DRAIN (OUTPUT) | | |
| 6. | DRAIN, #3 | 6. | CATHODE | 6. | COMMON DRAIN (OUTPUT) | | |
| 7. | DRAIN, #4 | 7. | CATHODE | 7. | COMMON DRAIN (OUTPUT) | | |
| 8. | DRAIN, #4 | 8. | CATHODE | 8. | SOURCE P-CH | | |
| 9. | GATE, #4 | 9. | ANODE | 9. | | | |
| 10. | SOURCE, #4 | 10. | ANODE | 10. | | | |
| 11. | GATE, #3 | 11. | | 11. | | | |
| 12. | SOURCE, #3 | | ANODE | 12. | | | |
| 13. | GATE, #2 | | ANODE | | GATE N-CH | | |
| 14. | SOURCE, #2 | | ANODE | | COMMON DRAIN (OUTPUT) | | |
| 15. | GATE, #1 | | ANODE | 15. | COMMON DRAIN (OUTPUT) | | |
| 16. | SOURCE, #1 | 16. | ANODE | 16. | SOURCE N-CH | | |
| | | | | | | | |

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